

# SDR SDRAM

## MT48LC2M32B2 – 512K x 32 x 4 Banks

### Features

- PC100-compliant
- Fully synchronous; all signals registered on positive edge of system clock
- Internal pipelined operation; column address can be changed every clock cycle
- Internal banks for hiding row access/precharge
- Programmable burst lengths: 1, 2, 4, 8, or full page
- Auto precharge, includes concurrent auto precharge and auto refresh modes
- Self refresh mode (not available on AT devices)
- Auto refresh
  - 64ms, 4096-cycle refresh (commercial and industrial)
  - 16ms, 4096-cycle refresh (automotive)
- LVTTL-compatible inputs and outputs
- Single 3.3V  $\pm$ 0.3V power supply
- Supports CAS latency (CL) of 1, 2, and 3

<b>Options</b>	<b>Marking</b>
• Configuration <ul style="list-style-type: none"> <li>– 2 Meg x 32 (512K x 32 x 4 banks)</li> </ul>	2M32B2
• Plastic package – OCPL <sup>1</sup> <ul style="list-style-type: none"> <li>– 86-pin TSOP II (400 mil) standard</li> <li>– 86-pin TSOP II (400 mil) Pb-free</li> <li>– 90-ball VFBGA (8mm x 13mm) Pb-free</li> </ul>	TG P B5
• Timing – cycle time <ul style="list-style-type: none"> <li>– 5ns (200 MHz)</li> <li>– 5.5ns (183 MHz)</li> <li>– 6ns (167 MHz)</li> <li>– 6ns (167 MHz)</li> <li>– 7ns (143 MHz)</li> </ul>	-5 -55 <sup>2</sup> -6A <sup>3</sup> -6 <sup>2</sup> -7 <sup>2</sup>
• Operating temperature range <ul style="list-style-type: none"> <li>– Commercial (0°C to +70°C)</li> <li>– Industrial (-40°C to +85°C)</li> <li>– Automotive (-40°C to +105°C)</li> </ul>	None IT AT <sup>4</sup>
• Revision	:G/J

- Notes:
1. Off-center parting line.
  2. Available only on revision G.
  3. Available only on revision J.
  4. Contact Micron for availability.

**Table 1: Key Timing Parameters**

CL = CAS (READ) latency

Speed Grade	Clock Frequency (MHz)	Target t <sub>RCD</sub> -t <sub>RP</sub> -CL	t <sub>RCD</sub> (ns)	t <sub>RP</sub> (ns)	CL (ns)
-5	200	3-3-3	15	15	15
-55	183	3-3-3	16.5	16.5	16.5
-6A	167	3-3-3	18	18	18
-6	167	3-3-3	18	18	18
-7	143	3-3-3	20	20	21

**Table 2: Address Table**

Parameter	2 Meg x 32
Configuration	512K x 32 x 4 banks
Refresh count	4K
Row addressing	2K A[10:0]
Bank addressing	4 BA[1:0]
Column addressing	256 A[7:0]

**Table 3: 64Mb (x32) SDR Part Numbering**

Part Numbers	Architecture	Package
MT48LC2M32B2TG	2 Meg x 32	86-pin TSOP II
MT48LC2M32B2P	2 Meg x 32	86-pin TSOP II
MT48LC2M32B2B5 <sup>1</sup>	2 Meg x 32	90-ball VFBGA

Note: 1. FBGA Device Decoder: [www.micron.com/decoder](http://www.micron.com/decoder).

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